## Silicon Epitaxial Planar Zener Diode for Surge Absorb

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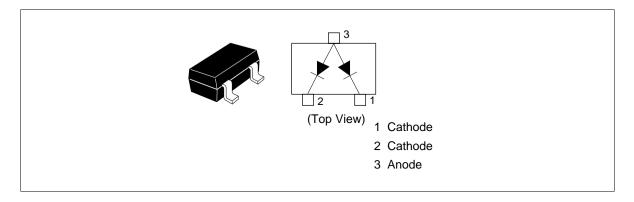
#### Features

- HZM6.2ZWA has two devices, and can absorb external + and -surge.
- Low capacitance (C=8.5pF max) and can protect ESD of signal line.
- MPAK Package is suitable for high density surface mounting and high speed assembly.

#### **Ordering Information**

Туре No.	Laser Mark	Package Code
HZM6.2ZWA	62Z	МРАК

#### Outline





## Absolute Maximum Ratings (Ta = $25^{\circ}$ C)

Item	Symbol	Value	Unit
Power dissipation	Pd <sup>*1</sup>	200	mW
Junction temperature	Тј	150	°C
Storage temperature	Tstg	-55 to +150	°C

Note 1. Two device total, See Fig.2.

### Electrical Characteristics (Ta = $25^{\circ}$ C) <sup>\*1</sup>

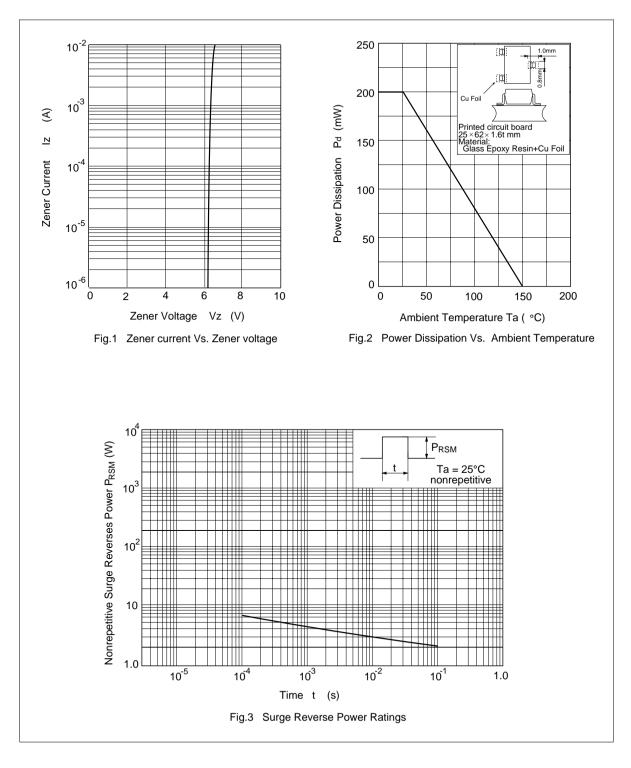
Item	Symbol	Min	Тур	Max	Unit	Test Condition
Zener voltage	Vz	5.90	_	6.50	V	$I_z = 5 \text{ mA}, 40 \text{ms pulse}$
Reverse current	I <sub>R</sub>	—		3	μΑ	$V_R = 5.5V$
Capacitance	С	—	8.0	8.5	pF	$V_R = 0V$ , f = 1 MHz
Dynamic resistance	<b>r</b> <sub>d</sub>	—	_	60	Ω	$I_z = 5 \text{ mA}$
ESD-Capability *2	—	13	_	_	kV	C =150pF, R = 330 $\Omega$ , Both forward and reverse direction 10 pulse

Notes 1. Per one device.

2. Failure criterion ; IR>3  $\mu$ A at VR = 5.5V.

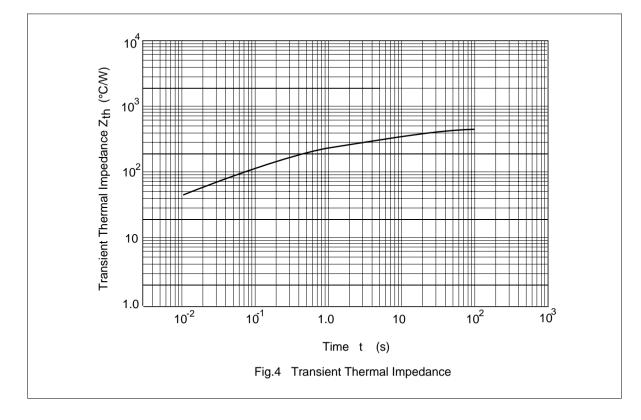
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#### Main Characteristic



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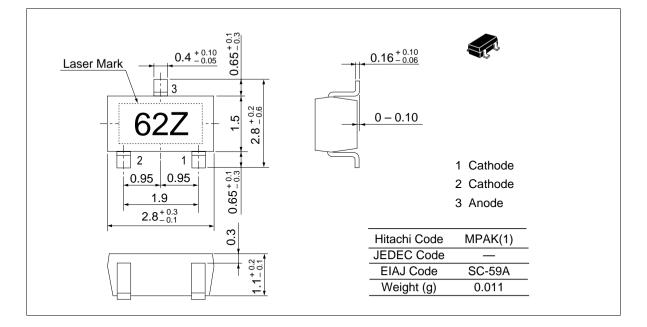
### Main Characteristic



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### **Package Dimensions**

Unit : mm



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Semiconductor & Integrated Circuits. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109 NorthAmerica URL http:semiconductor.hitachi.com/ http://www.hitachi-eu.com/hel/ecg Europe http://www.has.hitachi.com.sg/grp3/sicd/index.htm http://www.hitachi.com.tw/E/Product/SICD\_Frame.htm Asia (Singapore) Asia (Taiwan) Asia (HongKong) http://www.hitachi.com.hk/eng/bo/grp3/index.htm http://www.hitachi.co.jp/Sicd/indx.htm Japan For further information write to: Hitachi Semiconductor Hitachi Europe GmbH Hitachi Asia Pte. Ltd. (America) Inc. Electronic components Group 16 Collyer Quay #20-00 179 East Tasman Drive, Dornacher Stra§e 3 Hitachi Tower San Jose,CA 95134 D-85622 Feldkirchen, Munich Singapore 049318 Tel: <1> (408) 433-1990 Fax: <1>(408) 433-0223 Germany Tel: 535-2100 Tel: <49> (89) 9 9180-0 Fax: 535-1533 Fax: <49> (89) 9 29 30 00

 Fax: <49> (89) 9 29 30 00
 Hita

 Hitachi Europe Ltd.
 Hita

 Electronic Components Group.
 Taip

 Whitebrook Park
 3F,

 Lower Cookham Road
 Tun

 Maidenhead
 Tel:

 Berkshire SL6 8YA, United Kingdom
 Fax

 Tel: <44> (1628) 585000

 Fax: <44> (1628) 778322

Hitachi Asia Ltd. Taipei Branch Office 3F, Hung Kuo Building. No.167, Tun-Hwa North Road, Taipei (105) Tel: <886> (2) 2718-3666 Fax: <886> (2) 2718-8180

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Hitachi Asia (Hong Kong) Ltd. Group III (Electronic Components) 7/F., North Tower, World Finance Centre, Harbour City, Canton Road, Tsim Sha Tsui, Kowloon, Hong Kong Tel: <852> (2) 735 9218 Fax: <852> (2) 730 0281 Telex: 40815 HITEC HX

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